IN THE UNITED STATES DISTRICT COURT NORTHERN DISTRICT OF OHIO EASTERN DIVISION

HODELL-NATCO INDUSTRIES, INC.)	CASE NO. 1:08 CV 2755
Plaintiff,)	JUDGE WELLS
v.)	
SAP AMERICA, INC., et al.)	
Defendants.)	

SUPPLEMENTAL TRIAL EXHIBIT LIST OF SAP AMERICA, INC. AND SAP AG

SAP America, Inc. and SAP AG, through their undersigned counsel, and pursuant to this Court's pretrial order and Fed. R. Civ. P. 26(a)(3), hereby supplement their Trial Exhibit List with the following additional exhibits they expect to present at trial or/if the need arises. SAP America, Inc. and SAP AG reserve the right to modify this list as needed in response to those exhibits identified by the other parties.

<u>Trial</u> Exhibit	<u>Date</u>	Deposition Exhibit	<u>Description</u>	Bates Range
No.		No.		
SAP 109	09/20/1999	N/A	Correspondence from L. Goodwin to O. Reidl, attaching Software Solutions, Inc. Customer Registration Agreement, dated September 30, 1991	HODL039953- HODL039954
SAP 110	06/23/2003	N/A	Email chain between P. Boudreau, M. Betts, K. Reidl and E. Johnson	HODL003283
SAP 111	10/13/2003	N/A	Email chain between P. Boudreau, K. Reidl and D. Van Leeuwen	HODL003373
SAP 112	10/29/2003	N/A	Email chain between P. Boudreau, K. Reidl and D. Van Leeuwen	HODL003415

SAP 113	12/03/2003	N/A	Email from D. Van Leeuwen to K. Reidl and O. Reidl	HODL003418
SAP 114	12/03/2003	N/A	Email chain between K. Reidl, O. Reidl and D. Van Leeuwen	HODL003419
SAP 115	12/04/2003	N/A	Email from P. Vitantonio to O. Reidl, K. Reidl, D. Van Leeuwen et al.	HODL000092
SAP 116	12/05/2003	N/A	Email chain between O. Reidl, M. Betts, P. Vitantonio, K. Reidl, D. Van Leeuwen et al.	HODL003425- HODL003426
SAP 117	01/21/2004	N/A	Email from O. Reidl to D. Van Leeuwen	HODL003427
SAP 118	02/05/2004	N/A	Email from O. Reidl to D. Van Leeuwen	HODL003428
SAP 119	02/09/2004	N/A	Email chain between O. Reidl and D. Van Leeuwen	HODL003429
SAP 120	02/09/2004	N/A	Email chain between O. Reidl and D. Van Leeuwen	HODL003430
SAP 121	04/14/2004	N/A	Email from O. Reidl to D. Van Leeuwen	HODL003432
SAP 122	04/14/2004	N/A	Email chain between O. Reidl and D. Van Leeuwen	HODL003433- HODL003434
SAP 123	05/01/2004	N/A	Email from O. Reidl to D. Van Leeuwen	HODL003435
SAP 124	05/10/2004	N/A	Email from D. Van Leeuwen to K. Reidl	HODL003436
SAP 125	05/11/2004	N/A	Email from O. Reidl to D. Van Leeuwen	HODL003438
SAP 126	05/11/2004	N/A	Email from O. Reidl to D. Van Leeuwen	HODL003439
SAP 127	06/14/2004	N/A	Email from M. Betts to D. Van Leeuwen and K. Reidl	HODL003440
SAP 128	08/26/2004	N/A	Email from O. Reidl to D. Van Leeuwen	HODL003444

SAP 129	08/30/2004	N/A	Email chain between D. Van Leeuwen and K. Reidl	HODL003445
SAP 130	10/06/2004	N/A	Email chain between O. Reidl, D. Lowery, K. Reidl and D. Van Leeuwen	HODL003450
SAP 131	10/12/2004	N/A	Email chain between O. Reidl, D. Lowery, K. Reidl and D. Van Leeuwen	HODL003452- HODL003453
SAP 132	10/13/2004	N/A	Top Level Tasks as of Wed 10/13/04 – Inflight Enterprize Development	HODL00110
SAP 133	10/14/2004	N/A	Email from D. Van Leeuwen to O. Reidl, K. Reidl and D. Lowery, with attachments	HODL003454
SAP 134	10/14/2004	N/A	Attachment: Task Usage as of Wed 10/13/04 – Inflight Enterprize Development	HODL003455- HODL003468
SAP 135	10/14/2004	N/A	Attachment: SAP Development and Deployment Letter	HODL003469
SAP 136	10/14/2004	N/A	Attachment: Top Level Tasks as of Wed 10/13/04 – Inflight Enterprize Development	HODL003470
SAP 137	10/18/2004	N/A	Email chain between O. Reidl, D. Lowery, K. Reidl and D. Van Leeuwen	HODL003475
SAP 138	10/18/2004	N/A	Email chain between O. Reidl, D. Lowery, K. Reidl and D. Van Leeuwen	HODL003476
SAP 139	11/01/2004	N/A	Email from D. Van Leeuwen to O. Reidl, K. Reidl and D. Lowery, with attachment	HODL003477
SAP 140	11/01/2004	N/A	Attachment: SAP Business One Deployment Budget	HODL003478
SAP 141	11/03/2004	N/A	O. Reidl Handwritten note	HODL000160
SAP 142	11/04/2004	N/A	Email chain between D. Lowery, D. Kraus and D. Van Leeuwen	LSI02057477- LSI02057478
SAP 143	11/08/2004	N/A	Email from D. Van Leeuwen to O. Reidl, K. Reidl and D. Lowery	HODL000152- HODL000153

SAP 144	11/08/2004	N/A	Email from D. Van Leeuwen to O. Reidl and K. Reidl, with attachments	HODL003482
SAP 145	11/08/2004	N/A	Attachment: Pointech B1 Mobile Case Study	HODL003483- HODL003484
SAP 146	11/08/2004	N/A	Attachment: Pointech B1 Mobile Sales	HODL003485- HODL003486
SAP 147	11/11/2004	N/A	Email from O. Reidl to D. Lowery, D. Van Leeuwen, W. Rex and K. Reidl, with attachment	HODL003489
SAP 148	11/11/2004	N/A	Attachment: In-Flight Development and Implementation Agreement between Hodel and IBIS	HODL003490- HODL003491
SAP 149	11/23/2004	N/A	Email chain between O. Reidl, K. Reidl, D. Lowery and D. Van Leeuwen, with attachment	HODL020797_B
SAP 150	11/23/2004	N/A	Attachment: In-Flight Development and Implementation Agreement between Hodel and IBIS, dated Nov. 11, 2004	HODL020798_B- HODL020800_B
SAP 151	12/15/2004	N/A	Email chain between O. Reidl, K. Reidl, D. Lowery and D. Van Leeuwen, with attachment	HODL003502
SAP 152	07/31/2005	N/A	Email from J. Woodrum to D. Lowery, with attachment	LSI0207855
SAP 153	08/01/2005	N/A	Attachment: Draft correspondence Re: Repositioning and Responsibilities	LSI0207856- LSI0207858
SAP 154	10/13/2005	N/A	Email chain between D. Van Leeuwen, K. Reidl et al.	HODL003547- HODL003548
SAP 155	10/26/2005	N/A	Email chain between D. Kraus, T. Steffner, K. Lorenz, Jr. et al.	SAP00000332- SAP00000333
SAP 156	12/22/2005	295	Email from D. Lowery to T. Steffner, T. Lowe, D. Van Leeuwen, attaching SBOUS Pricing Royalty Spreadsheet	LSI01579159- LSI01579163
SAP 157	01/24/2006	N/A	Email chain between G. Barnea, A. Myrik et al.	LSI0157138- LSI0157142

SAP	03/20/2006	N/A	Memorandum Re: SAP In-Flight	HODL00184-
158	03/20/2000	11/11	Enterprise Development and	HODL00184-
	0.5400 (5.55	1 / .	Hodell-Natco Implementation	*****
SAP	06/08/2006	N/A	Email chain between J. Woodrum	HODL006070-
159			and K. Reidl	HODL006072
SAP	12/20/2006	N/A	Email from K. Reidl to C.	HODL008998
160	12/20/2000	14/21	Woodrum and C. Wong	HODE
100			Woodrum and C. Wong	
SAP	01/11/2007	N/A	Email chain between D. Reidl, C.	HODL009475-
161		- "	Woodrum, M. Weissman et al.	HODL009476
101			Woodram, W. Weissman et al.	110DE007170
SAP	2008	N/A	Fastener Industry Transactions	HODL040692-
162			, J	HODL040731
102				110220.0701
SAP	N/A	N/A	O. Reidl Handwritten note	HODL00107
163				
SAP	N/A	N/A	A Complete Solution for	LSI00894312-
164			Distributors	LSI00894316
SAP	02/28/2003	N/A	Email from D. Van Leeuwen to K.	HODL003172
165			Reidl	
SAP	01/12/2007	57	Email from J. Woodrum to K.	HODL009500-
166			Reidl	HODL009503
SAP	11/01/2006	N/A	Email from M. Weissman to J.	HODL008024-
167			Woodrum	HODL008025
SAP	06/25/2007	N/A	Email from D. Lowery to J.	LSI-000176
	00/23/2007	1 N / <i>F</i> A	Woodrum	L31-0001/0
168			W OOGIUIII	
SAP	09/18/2004	N/A	Email from D. Lowery to D.	LSI-000457-
169	07/10/2004	1 1/71	Kraus	LSI-000457- LSI-000462
109			Maus	LDI-000402
SAP	11/16/2007	N/A	Email from D. Lowery to Otto &	HODL018497-
170	11/10/2007	14/71	K. Reidl	HODL018498
	10/10/2000	77/4		
SAP	12/16/2009	N/A	Email from J. Woodrum to D.	LSI-02183718-
171			Lowery	LSI-02183719
SAP	11/19/2007	N/A	Email from K. Reidl to O. Reidl	HODL023892
172				
SAP	10/15/2004	N/A	Email from O. Reidl to William	HODL003473-
173	10/13/2004	1 1/ /7	Rex & K. Reidl	HODL003474
1/3			NGA & IX. NOIUI	11000004/4

SAP 174	12/26/2007	N/A	SAP Sizing Estimate for Hodell-Natco	HODL024641- HODL024668
SAP 175	12/20/2004	N/A	Copy of Purchase Order & Check	HODL00613- HODL00615
SAP 176	11/03/2006	N/A	Letter from K. Reidl to D. Lowery	HODL010171
SAP 177	09/20/1991	N/A	Letter from SOF-TEK to O. Reidl	HODL039953- HODL039954
SAP 178	03/09/2007	N/A	Email from K. Reidl to cle@hodell-natco.com	HODL022799
SAP 179	01/02/2008	N/A	Email from K. Reidl to cle@hodell-natco.com	HODL018681- HODL018682
SAP 180	03/16/2009	N/A	Email from S. Marks to K. Reidl	HODL024741- HODL024742
SAP 181	05/15/2007	N/A	Email from K. Reidl to J. Woodrum, D. Lowery & R. Elliott	LSI-02121404- LSI-02121404
SAP 182	10/20/2003	7	SAP Business One	HODL00535
SAP 183	9/10/2004	N/A	Notes from D. Van Leeuwen & D. Lowery meeting	HODL00111- HODL00112
SAP 184	01/11/2008	N/A	Notes from telephone call between Dan Krause & Paul Killingsworth	HODL00265
SAP 185	N/A	N/A	Notes	HODL00149- HODL-00150
SAP 186	05/17/2005	140	Email from J. Woodrum to D. Lowery	LSI-01054380- LSI-01054381
SAP 187	01/23/2008	N/A	Email from O. Reidl to D. Lowery & K. Reidl	HODL018785- HODL018787
SAP 188	1/16/2007	58	Email from D. Lowery to J. Woodrum	HODL009659
SAP 189	5/11/2007	N/A	Notes from D. Lowery, J. Guagenti, J. Woodrum & Avery telephone conference	HODL00248
SAP 190	08/10/2007	N/A	Notes from D. Lowery & J. Woodrum telephone conference	HODL00250
SAP 191	12/14/2005	N/A	Email from D. Kraus to T. Steffner	SAP00000329- SAP00000330
SAP 192	12/10/2004	N/A	Fax from D. Lowery to Dale Jeffries	LSI-000286- LSI-000288

SAP 193	06/06/2006	N/A	Email from D. Lowery to O. Reidl	HODL006066- HODL006068
SAP 194	12/08/2006	N/A	Email from J. Woodrum to D. Lowery	HODL008866- HODL008869
SAP 195	01/05/2007	N/A	Handwritten notes	HODL00402
SAP 196	02/16/2007	N/A	Email from M. Weissman to K. Reidl	HODL010272- HODL010273
SAP 197	03/13/2006	N/A	Email from E. Neveux to R. Mehnert-Meland	SAP00004034- SAP00004035
SAP 198	12/11/2006	N/A	Email from J. Woodrum to K. Reidl	HODL008890- HODL008893
SAP 199	05/18/2004	N/A	Stock Purchase Agreement	LSI-000349- LSI-000369
SAP 200	10/26/2005	136	Email chain between D. Kraus, T. Steffner, K. Lorenz, Jr. et al.	SAP00000334
SAP 201	5/16/2005	139	Email chain between J. Woodrum, A. Myrick, D. Lowery et al.	LSI01054376- LSI01054377
SAP 202	10/10/2005	216	Email from J. Woodrum to D. Lowery, D. VanLeeuwen and A. Myrick	LSI01056174
SAP 203	6/26/2007	224	Email chain between D. Lowery, J. Woodrum, K. Reidl and M. Weissman et al.	LSI-000407- LSI-000410

Respectfully submitted,

/s/ Gregory J. Star

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Attorney for SAP America, Inc. and SAP AG

CERTIFICATE OF SERVICE

I hereby certify that on this 8th day of October, 2014, copies of the foregoing Supplemental Trial Exhibit List of SAP America, Inc. and SAP AG was filed and served electronically on Hodell-Natco Industries, Inc. via ECF and was sent by First Class Mail pursuant to Fed. R. Civ. P. 5(b)(2)(F) to the following parties:

LSI-Lowery Systems, Inc.

c/o Timothy K. Kellett 911 Washington Ave., Suite 400 St. Louis, MO 63101

IBIS Group, Inc.

c/o Dale Van Leeuwen 1800 W. Hawthorne Lane, Suite N West Chicago, IL 60185

> /s/ Gregory J. Star Gregory J. Star (admitted *pro hac vice*)